## CRYSTAL GROUP G2 2600 SERIES SERVERS



## TAKE REAL-TIME AI & ML FROM THE DATA CENTER TO THE EDGE

Equipped with up to four state-of-the-art GPUs and two Intel® Xeon® Scalable or AMD EPYC™ processors in an unmatched rugged design, the FG2 2600 Series servers deliver exceptional reliability and Tensor Core performance at the tactical edge. Up to eight NVMe or sixteen SATA/SAS drives can be configured for CSfC data storage for applications requiring FIPS 140-2 certification.

Designed to handle challenging, yet critical inference obstacles, the extreme, scalable compute power of the FG2 2600 Series brings ultra-low latency and seamless operation to the most volatile, mission-critical conditions when real-time situational awareness and AI can't be compromised. InfiniBand I/O connectivity provides critical, rapid data transfer for low-latency backhaul applications.

This NVIDIA-Certified System is validated for optimal performance, manageability, security and scalability.

Crystal Group provides a 5-year warranty and forward-looking configuration management to enhance the long-term investment of your compute solution.



BUGGED TECH. ZERO LIMITS.



## USE CASES

- visualization
- Command and control communications
- · Intelligence gathering and processing
- Data storage server
- Battlespace management and
   Sensor fusion for air and ground vehicles
  - Leader-follower autonomous vehicles
  - · GPU server
  - · Virtualization platform

## **CRYSTAL GROUP FG2 2600 SERIES TECHNICAL SPECIFICATIONS**

| Mechanical   | Height: 3.5" (8.89 cm)<br>Width: 17.5" (44.45 cm)<br>Depth: 19" (48.3 cm) or 22" (58.88 cm)<br>Weight: 32–38 lbs (14.51–17.23 kg)  |
|--|--|
| Mounting   | Glides, fixed mount (front and rear), or Jonathan rails  |
| Power Supply   | 800WAC, 1005W 18-36VDC, or 1200W AC 1+1  |
| CPU Architecture   | 5th Generation Intel Xeon Scalable or AMD EPYC 9004 series processors<br>Up to 48 core per socket (motherboard dependent)  |
| Memory   | 16GB-2TB DDR4 ECC SDRAM (motherboard dependent)  |
| Expansion  | Up to six low-profile PCIe slots   |
| External Bays  | Option 1: Up to 16 SATA or SAS SSDs<br>Option 2: Up to 8 U.2/U.3 NVME SSDs<br>Optional optical drive   |
| Software<br>Compatibility  | Windows 11, Windows Server, VMware, Linux  |
| ENVIRONMENTAL TESTING STANDARDS  |  |
|  |  |
| Environmental<br>Engineering<br>Considerations and<br>Laboratory Tests                                 | Method 500, Altitude: 12,500 ft. operation, 40,000 ft. transport <sup>2</sup><br>Method 501, Operational Temperature, high: Procedure II: +50°C, two-hour dwell, four cycles <sup>1</sup><br>Method 502, Operational Temperature, low: Procedure II: -30°C, two-hour dwell, four cycles <sup>1</sup><br>Method 503, Thermal Shock: Procedure II: 10 cycles, -40°C to +55°C, 15-min dwell, <1-min transfer time <sup>2</sup><br>Method 507, Humidity: Procedure II: 240 hours with optional conformal coating kit <sup>1</sup><br>Method 508, Fungus: 28 days, mixed spore, 30°C 95% RH <sup>2</sup><br>Method 509, Salt fog: 48-hour test <sup>2</sup><br>Method 510, Sand-Dust: Procedure I: Blasting dust, 12 hours <sup>2</sup><br>Method 513, Acceleration: Procedure II: 9g <sup>2</sup><br>Method 514, Vibration: Procedure I: 4.76, 5-2,000Hz, 60 min/axis, 3 axis <sup>1</sup><br>Method 516, Shock: Procedures I & V: 40G, 11ms, 18 pulses, 3/axis both directions <sup>1</sup>   |
| Engineering<br>Considerations and  | Method 501, Operational Temperature, high: Procedure II: +50°C, two-hour dwell, four cycles <sup>1</sup><br>Method 502, Operational Temperature, low: Procedure II: -30°C, two-hour dwell, four cycles <sup>1</sup><br>Method 503, Thermal Shock: Procedure II: 10 cycles, -40°C to +55°C, 15-min dwell, <1-min transfer time <sup>2</sup><br>Method 507, Humidity: Procedure II: 240 hours with optional conformal coating kit <sup>1</sup><br>Method 508, Fungus: 28 days, mixed spore, 30°C 95% RH <sup>2</sup><br>Method 509, Salt fog: 48-hour test <sup>2</sup><br>Method 510, Sand-Dust: Procedure I: Blasting dust, 12 hours <sup>2</sup><br>Method 513, Acceleration: Procedure II: 9g <sup>2</sup><br>Method 514, Vibration: Procedure II: 4.76, 5-2,000Hz, 60 min/axis, 3 axis <sup>1</sup>   |
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| Engineering<br>Considerations and<br>Laboratory Tests<br>MIL-STD-1474E                                 | Method 501, Operational Temperature, high: Procedure II: +50°C, two-hour dwell, four cycles <sup>1</sup><br>Method 502, Operational Temperature, low: Procedure II: -30°C, two-hour dwell, four cycles <sup>1</sup><br>Method 503, Thermal Shock: Procedure II: 10 cycles, -40°C to +55°C, 15-min dwell, <1-min transfer time <sup>2</sup><br>Method 507, Humidity: Procedure II: 240 hours with optional conformal coating kit <sup>1</sup><br>Method 508, Fungus: 28 days, mixed spore, 30°C 95% RH <sup>2</sup><br>Method 509, Salt fog: 48-hour test <sup>2</sup><br>Method 510, Sand-Dust: Procedure I: Blasting dust, 12 hours <sup>2</sup><br>Method 513, Acceleration: Procedure II: 9g <sup>2</sup><br>Method 514, Vibration: Procedure I: 4.7G, 5-2,000Hz, 60 min/axis, 3 axis <sup>1</sup><br>Method 516, Shock: Procedures I & V: 40G, 11ms, 18 pulses, 3/axis both directions <sup>1</sup><br>Acoustic Noise, Requirement S, Grade A3 <sup>2</sup>  |
| Engineering<br>Considerations and<br>Laboratory Tests<br>MIL-STD-1474E<br>MIL-STD-167-1A<br>MIL-S-901E | <ul> <li>Method 501, Operational Temperature, high: Procedure II: +50°C, two-hour dwell, four cycles <sup>1</sup></li> <li>Method 502, Operational Temperature, low: Procedure II: -30°C, two-hour dwell, four cycles <sup>1</sup></li> <li>Method 503, Thermal Shock: Procedure II: 10 cycles, -40°C to +55°C, 15-min dwell, &lt;1-min transfer time <sup>2</sup></li> <li>Method 507, Humidity: Procedure II: 240 hours with optional conformal coating kit <sup>1</sup></li> <li>Method 508, Fungus: 28 days, mixed spore, 30°C 95% RH <sup>2</sup></li> <li>Method 509, Salt fog: 48-hour test <sup>2</sup></li> <li>Method 510, Sand-Dust: Procedure I: Blasting dust, 12 hours <sup>2</sup></li> <li>Method 513, Acceleration: Procedure II: 9g <sup>2</sup></li> <li>Method 514, Vibration: Procedure I: 4.7G, 5-2,000Hz, 60 min/axis, 3 axis <sup>1</sup></li> <li>Method 516, Shock: Procedures I &amp; V: 40G, 11ms, 18 pulses, 3/axis both directions <sup>1</sup></li> <li>Acoustic Noise, Requirement S, Grade A3 <sup>2</sup></li> <li>Ship Vibration, Type 1<sup>1</sup></li> </ul> |
| Engineering<br>Considerations and<br>Laboratory Tests<br>MIL-STD-1474E<br>MIL-STD-167-1A<br>MIL-S-901E | Method 501, Operational Temperature, high: Procedure II: +50°C, two-hour dwell, four cycles <sup>1</sup><br>Method 502, Operational Temperature, low: Procedure II: -30°C, two-hour dwell, four cycles <sup>1</sup><br>Method 503, Thermal Shock: Procedure II: 10 cycles, -40°C to +55°C, 15-min dwell, <1-min transfer time <sup>2</sup><br>Method 507, Humidity: Procedure II: 240 hours with optional conformal coating kit <sup>1</sup><br>Method 508, Fungus: 28 days, mixed spore, 30°C 95% RH <sup>2</sup><br>Method 509, Salt fog: 48-hour test <sup>2</sup><br>Method 510, Sand-Dust: Procedure II: Blasting dust, 12 hours <sup>2</sup><br>Method 513, Acceleration: Procedure II: 9g <sup>2</sup><br>Method 514, Vibration: Procedure II: 9g <sup>2</sup><br>Method 516, Shock: Procedures I & V: 40G, 11ms, 18 pulses, 3/axis both directions <sup>1</sup><br>Acoustic Noise, Requirement S, Grade A3 <sup>2</sup><br>Ship Vibration, Type 1 <sup>1</sup><br>Shipboard Shock, Class II, A/B <sup>2</sup>  |

In-house test reports provided for baseline units; customer-specific test options available upon request. 1: Test report available

2: Testing in progress

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